### TITLE: COPPER ELECTROLESS DEPOSITION TECHNOLOGY FOR ULSI METALIZATION INVENTORS NAME: Kie Y. Ahn et al. DOCKET NO.: 1303.016US1

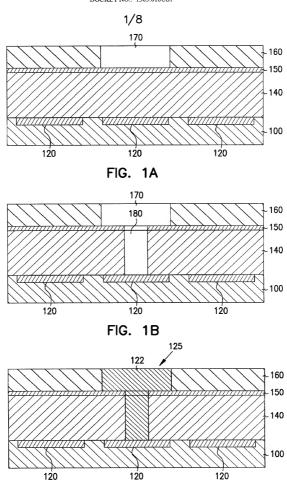


FIG. 1C

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FIG. 2A

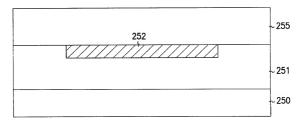


FIG. 2B

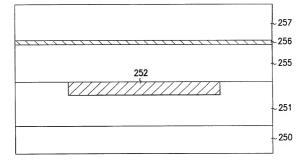


FIG. 2C

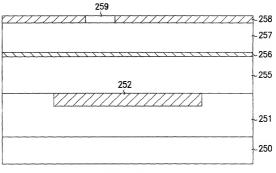


FIG. 2D

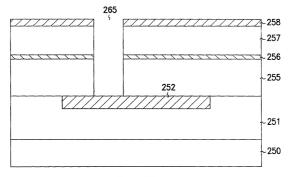


FIG. 2E

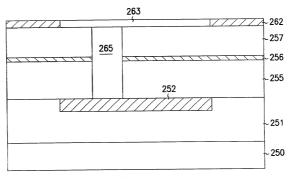


FIG. 2F

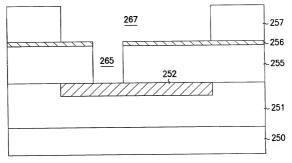


FIG. 2G

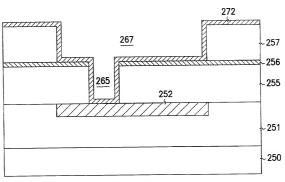


FIG. 2H

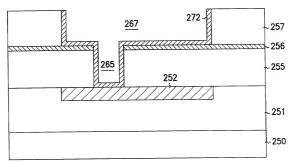
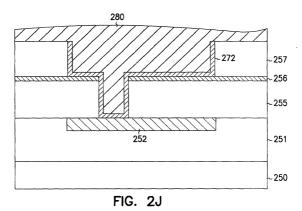
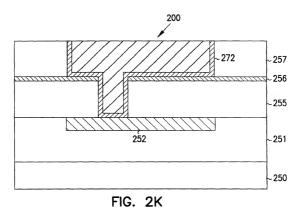


FIG. 2I





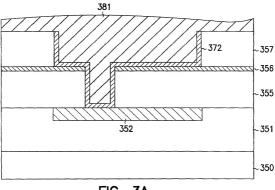


FIG. 3A

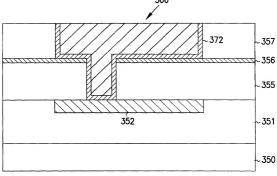


FIG. 3B

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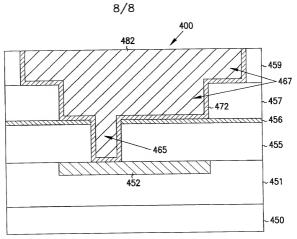


FIG. 4

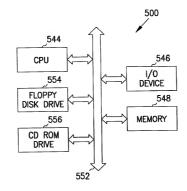


FIG. 5